COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CHIP PACKAGE AND PROCESS THEREOF

the	specification of which	ch				
X 	is attached hereto. was filed on as Application Ser		ar	nd was amended on		·
api api for	ecification, including to a cknowledge the olication in accordance I hereby claim fore olication(s) for patentication(s)		ed by ar ormation of Fede nder Tit cate list	ny amendment referrency which is material to be ral Regulations, § 1. Itel 35, United States Coted below and have	ed to above. the patent .56(a). Code, § 119 also identifi	ability of this of any foreign ed below any
	Number	Country	Date	Filed(yyyy/mm/dd)	Yes	No
	93105477	Taiwan, R.O.C.		2004/3/3		Х
tra	I hereby appoint the following attorney(s) are transact all business in the Patent and Trademark Jiawei Huang (Reg. No. 43,330) Maria Erlinda C. Sarno (Reg. No. 37,436) Belinda Lee (Reg. No. 46,863) SEND CORRESPONDENCE TO: J.C. Patents, Inc. 4 Venture, Suite 250 Irvine, CA 92618 (949) 660-0761					. 39,081)
				DIRECT TELEPHONE CALLS TO: (Name and telephone number) Jiawei Huang (949) 660-0762		

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such

willful false statements may jeopardize the validity of the application or any patents issued thereon. Date: March 12, 2004 Signature: Sole or First Joint Inventor Citizenship: Taiwan, R.O.C. Residence and Post Office Address: No. 12-4, Chu-Tsun II Rd., Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C. Signature: Kat-Kuang Ho Date: March 12, 2004 Second Joint Inventor (if any): Kai-Kuang Ho Citizenship: Taiwan, R.O.C. Residence and Post Office Address: 18F.-4, No.17, Lane 175, Wuling Rd., Hsinchu City 300, Taiwan, R.O.C. Signature: Kno-ming Chen Date: March 12, 2004 Third Joint Inventor (if any): Kuo-Ming Chen Citizenship: Taiwan, R.O.C. Residence and Post Office Address: No.16-1, Dalin Village, Beipu Township, Hsinchu County 314, Taiwan, R.O.C. Signature: Kuang - Hui Tang Date: March 12, 2004

Fourth Joint Inventor (if any): Kuang-Hui Tang Citizenship: Taiwan, R.O.C. Residence and Post Office Address: 13F., No.1, Lane 249, Rueising Rd., Fongshan City, Kaohsiung

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